

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T.R. Cundiff et al. Attorney Docket No.: BOCO122200
Patent No.: 7,147,895 B2 Application No.: 10/758,404
Issued: December 12, 2006 Filing Date: January 15, 2004
Confirmation No.: 6099
Title: RESIN TRANSFER MOLDING PROCESS

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February 21, 2007

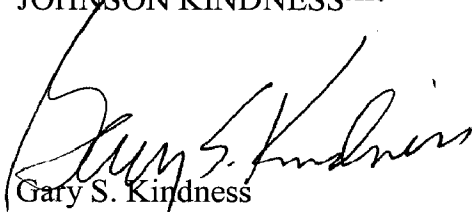
TO THE COMMISSIONER FOR PATENTS:

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